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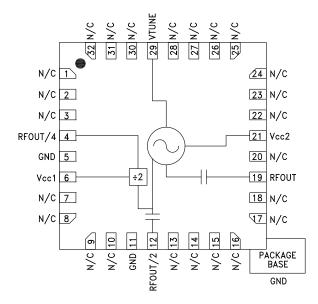
MMIC VCO w/ HALF FREQUENCY OUTPUT & DIVIDE-BY-4, 11.5 - 12.5 GHz

Typical Applications

Low noise MMIC VCO w/Half Frequency, Divide-by-4 Outputs for:

- VSAT Radio
- Point to Point/Multipoint Radio
- Test Equipment & Industrial Controls
- Military End-Use

Functional Diagram



Features

Dual Output: Fo = 11.5 - 12.5 GHz Fo/2 = 5.75 - 6.25 GHz

Pout: +10 dBm

Phase Noise: -110 dBc/Hz @100 kHz Typ.

No External Resonator Needed

32 Lead 5x5mm SMT Package: 25mm²

General Description

The HMC515LP5 & HMC515LP5E are GaAs InGaP Heterojunction Bipolar Transistor (HBT) MMIC VCOs. The HMC515LP5 & HMC515LP5E integrate resonators, negative resistance devices, varactor diodes and feature half frequency and divide-by-4 outputs. The VCO's phase noise performance is excellent over temperature, shock, and process due to the oscillator's monolithic structure. Power output is +10 dBm typical from a +5V supply voltage. The prescaler function can be disabled to conserve current if not required. The voltage controlled oscillator is packaged in a leadless QFN 5x5 mm surface mount package, and requires no external matching components.

Electrical Specifications, $T_A = +25^{\circ}$ C, Vcc1, Vcc2 = +5V

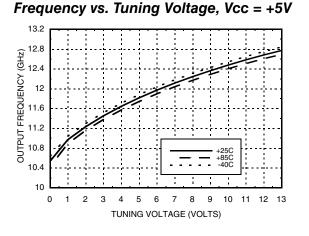
Parameter		Min.	Тур.	Max.	Units
Frequency Range	Fo Fo/2		11.5 - 12.5 5.75 - 6.25		GHz GHz
Power Output	RFOUT RFOUT/2 RFOUT/4	+6 +3 -9		+15 +9 -3	dBm dBm dBm
SSB Phase Noise @ 100 kHz Offset, Vtune= +5V @ RFOUT			-110		dBc/Hz
Tune Voltage	Vtune	2		13	V
Supply Current	lcc1 & lcc2	160	200	240	mA
Tune Port Leakage Current (Vtune= 13V)				10	μA
Output Return Loss			2		dB
Harmonics/Subharmonics	1/2 3/2 2nd 3rd		30 35 24 40		dBc dBc dBc dBc
Pulling (into a 2.0:1 VSWR)			8		MHz pp
Pushing @ Vtune= 5V			6		MHz/V
Frequency Drift Rate			1.2		MHz/°C

For price, delivery and to place orders: Hittite Microwave Corporation, 20 Alpha Road, Chelmsford, MA 01824 Phone: 978-250-3343 Fax: 978-250-3373 Order On-line at www.hittite.com Application Support: Phone: 978-250-3343 or apps@hittite.com

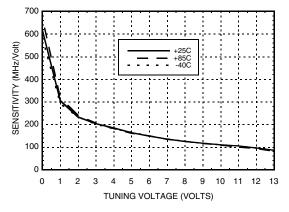




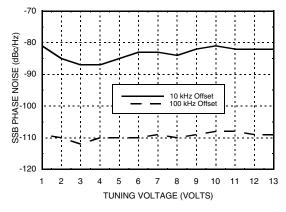
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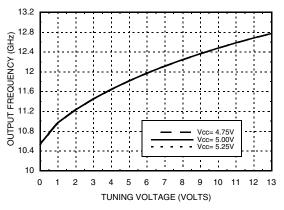
Sensitivity vs. Tuning Voltage, Vcc= +5V



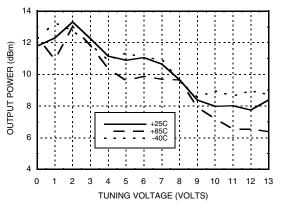
SSB Phase Noise vs. Tuning Voltage



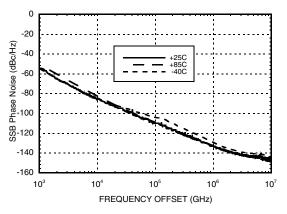




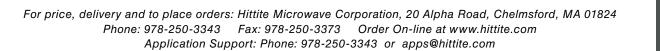
Output Power vs. Tuning Voltage, Vcc= +5V



SSB Phase Noise @ Vtune= +5V



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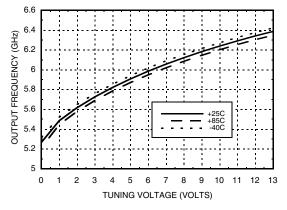




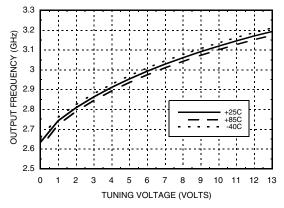


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RFOUT/2 Frequency vs. Tuning Voltage, Vcc= +5V

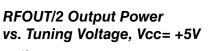


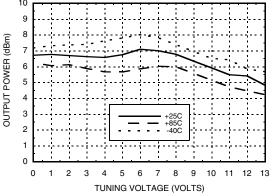
Divide-by-4 Frequency vs. Tuning Voltage, Vcc= +5V



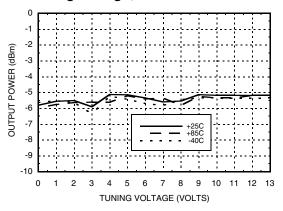
Absolute Maximum Ratings

Vcc1, Vcc2	+5.5 Vdc
Vtune	0 to +15V
Junction Temperature	135 °C
Continuous Pdiss (T=85 °C) (derate 28.6 mW/C above 85 °C	1.43 W
Thermal Resistance (junction to ground paddle)	35 °C/W
Storage Temperature	-65 to +150 °C
Operating Temperature	-40 to +85 °C
ESD Sensitivity (HBM)	Class 1A





Divide-by-4 Output Power vs. Tuning Voltage, Vcc= +5V



Typical Supply Current vs. Vcc

Vcc (V)	Icc (mA)
4.75	180
5.00	200
5.25	220

Note: VCO will operate over full voltage range shown above.



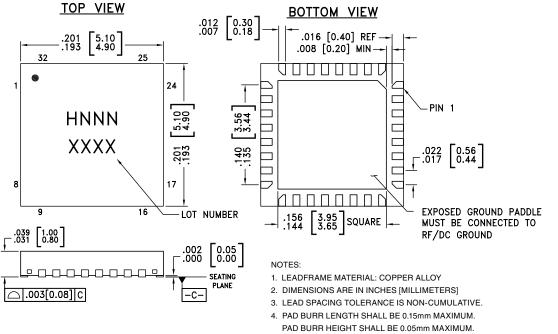
ELECTROSTATIC SENSITIVE DEVICE OBSERVE HANDLING PRECAUTIONS

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MMIC VCO w/ HALF FREQUENCY OUTPUT & DIVIDE-BY-4, 11.5 - 12.5 GHz

Outline Drawing



- 5. PACKAGE WARP SHALL NOT EXCEED 0.05mm.
- 6. ALL GROUND LEADS AND GROUND PADDLE MUST BE SOLDERED TO PCB RF GROUND.
- 7. REFER TO HITTITE APPLICATION NOTE FOR SUGGESTED LAND PATTERN.

Package Information

Part Number	Package Body Material	Lead Finish	MSL Rating	Package Marking ^[3]
HMC515LP5	Low Stress Injection Molded Plastic	Sn/Pb Solder	MSL3 ^[1]	H515 XXXX
HMC515LP5E	HMC515LP5E RoHS-compliant Low Stress Injection Molded Plastic		MSL3 ^[2]	<u>H515</u> XXXX

[1] Max peak reflow temperature of 235 $^\circ\text{C}$

[2] Max peak reflow temperature of 260 °C

[3] 4-Digit lot number XXXX

Pin Descriptions

Pin Number	Function	Description	Interface Schematic
1 - 3, 7 - 10, 13 - 18, 20, 22 - 28, 30 - 32	N/C	No Connection. These pins may be connected to RF/ DC ground. Performance will not be affected.	
4	RFOUT/4	Divide-by-4 Output.	ORFOUT/4
6	Vcc1	Supply Voltage for prescaler. If prescaler is not required, this pin may be left open to conserve 65 mA of current.	Vcc10

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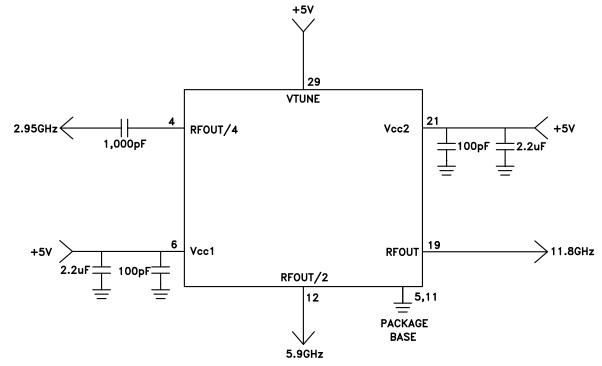


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Pin Descriptions

Pin Number	Function	Description	Interface Schematic
12	RFOUT/2	Half frequency output (AC coupled).	
19	RF OUT	RF output (AC coupled).	
21	Vcc2	Supply Voltage, +5V	Vcc2 O
29	VTUNE	Control Voltage and Modulation Input. Modulation bandwidth dependent on drive source impedance. See "Determining the FM Bandwidth of a Wideband Varac- tor Tuned VCO" application note.	$ \begin{array}{c} 3nH \\ VTUNE \circ \\ 4pF \\ $
5, 11, Paddle	GND	Package bottom has an exposed metal paddle that must be connected to RF/DC ground.	

Typical Application Circuit

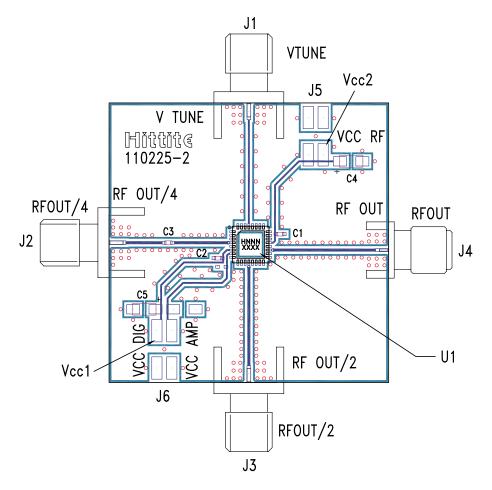


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Evaluation PCB



List of Materials for Evaluation PCB 110227 [1]

Item	Description
J1 - J4	PCB Mount SMA RF Connector
J5 - J6	2 mm DC Header
C1 - C2	100 pF Capacitor, 0402 Pkg.
C3	1,000 pF Capacitor, 0402 Pkg.
C4 - C5	2.2 µF Tantalum Capacitor
U1	HMC515LP5 / HMC515LP5E VCO
PCB [2]	110225 Eval Board

Reference this number when ordering complete evaluation PCB
 Circuit Board Material: Rogers 4350

The circuit board used in the application should use RF circuit design techniques. Signal lines should have 50 Ohm impedance while the package ground leads and backside ground paddle should be connected directly to the ground plane similar to that shown. A sufficient number of via holes should be used to connect the top and bottom ground planes. The evaluation circuit board shown is available from Hittite upon request.